TOSHIBA HIGH EFFICIENCY DIODE STACK (HED) SILICON EPITAXIAL TYPE

U20JL2C48A

SWITCHING MODE POWER SUPPLY APPLICATION CONVERTER & CHOPPER APPLICATION

Repetitive Peak Reverse Voltage : VRRM = 600V
 Average Output Rectified Current : IO = 20A
 Ultra Fast Reverse-Recovery Time : trr = 35ns (Max)

• Low Switching Losses and Output Noise.

ABSOLUTE MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	RATING	UNIT
Repetitive Peak Reverse Voltage	V_{RRM}	600	\ \ \
Average Output Rectified Current	Io	20	
Peak One Cycle Surge Forward Current (Sin Wave)	I _{FSM}	80 (50Hz)	$\langle \langle \rangle \rangle$
		88 (60Hz)	(1)
Junction Temperature	Tj	-40~150	S
Storage Temperature Range	T _{stg}	-40~150	> ℃

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Unit: mm

3
10.3 MAX.

1.32

2.54±0.25

1. ANODE
2. ANODE
3. CATHODE (HEAT SINK)

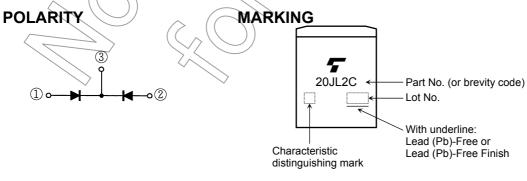
JEDEC
JEHTA
TOSHIBA
12–10D2A

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

ELECTRICAL CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN	MAX	UNIT
Peak Forward Voltage	V _{FM}	1 _{EM} = 10A	_	3.2	V
Repetitive Peak Reverse Current	IRRM	V _{RRM} = 600V	_	50	μΑ
Reverse Recovery Time	t _{rr}	J _F = 2A, di / dt = −50A / μs	_	35	ns
Forward Recovery Time	t _{fr}	1 _F = 1,A	_	100	ns
Thermal Resistance	R _{th∕(j>c)}	Total DC, Junction to Case	1	1.6	°C/W

Note 1: V_{FM}, I_{RRM}, t_{rr}, t_{fr} ····· A value applied to one cell.



Abbreviation Code	Part No.
20JL2C	U20JL2C48A

Handling Precaution

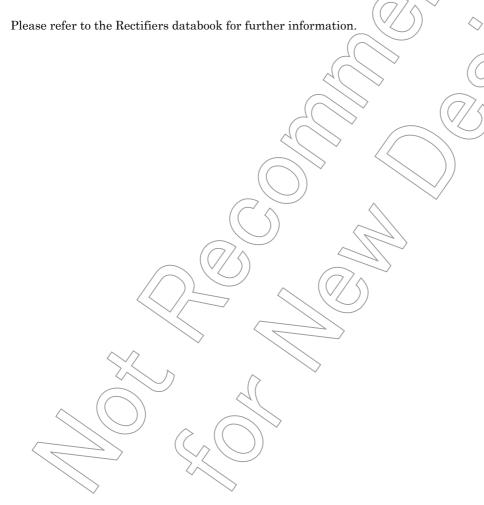
The absolute maximum ratings denote the absolute maximum ratings, which are rated values and must not be exceeded during operation, even for an instant. The following are the general derating methods that we recommend when you design a circuit with a device.

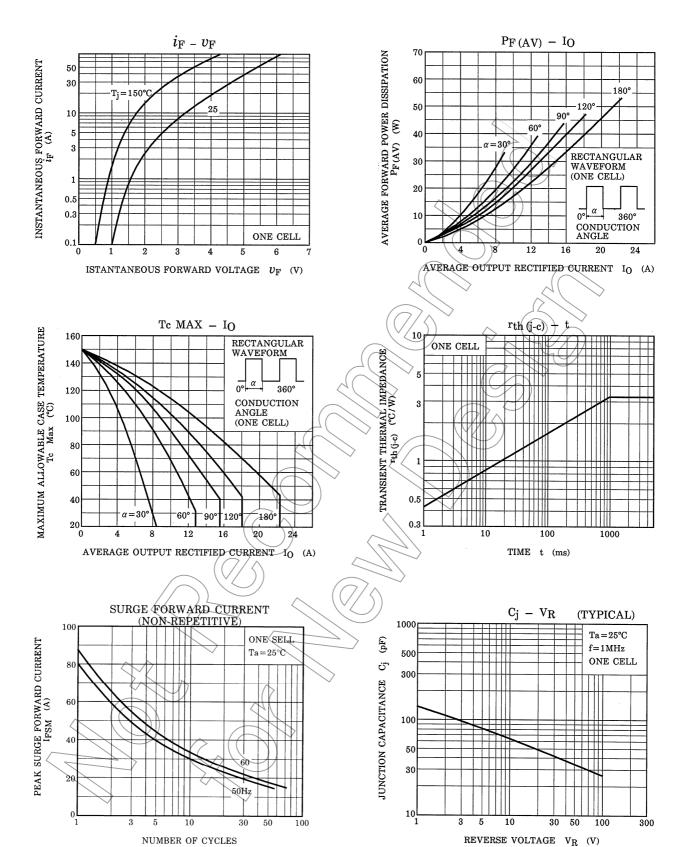
VRRM: We recommend that the worst case voltage, including surge voltage, be no greater than 80% of the absolute maximum rating of VRRM for a DC circuit and be no greater than 50% of that of VRRM for an AC circuit. VRRM has a temperature coefficient of 0.1%/°C. Take this temperature coefficient into account designing a device at low temperature.

Io: We recommend that the worst case current be no greater than 80% of the absolute maximum rating of Io. Carry out adequate heat design. If you can't design a circuit with excellent heat radiation, set the margin by using an allowable Tamax-Io curve.

This rating specifies the non-repetitive peak current in one cycle of a 50-Hz sine wave, condition angle 180. Therefore, this is only applied for an abnormal operation, which seldom occurs during the lifespan of the device.

We recommend that a device be used at a Tj of below 120°C under the worst load and heat radiation conditions.







RESTRICTIONS ON PRODUCT USE

20070701-EN

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 In developing your designs, please ensure that TOSHIBA products are used within specified operating ranges as set forth in the most recent TOSHIBA products specifications. Also, please keep in mind the precautions and conditions set forth in the "Handling Guide for Semiconductor Devices," or "TOSHIBA Semiconductor Reliability Handbook" etc.
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